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(71)Name of Applicant :
1)St. Martin’s Engineering College
 Address of Applicant :St.Martin's Engineering College, Dhulapally Kompally Secunderabad -----
Name of Applicant : NA
Address of Applicant : NA

(72)Name of Inventor :
1)Dr. Regonda Nagaraju Professor& HoD IT Department
 Address of Applicant :St.Martin's Engineering College, Dhulapally Kompally Secunderabad -----
2)Dr. P. Santosh Kumar Patra Professor , Dept.of CSE
 Address of Applicant :St.Martin's Engineering College, Dhulapally Kompally Secunderabad -----
3)Dr.B.Laxmikantha Professor IT Department
 Address of Applicant :St.Martin's Engineering College, Dhulapally Kompally Secunderabad -----
4)Gunreddy Vivek Reddy Student, IT
 Address of Applicant :St.Martin's Engineering College, Dhulapally Kompally Secunderabad -----
5)Gurram Anuteja Reddy Student, IT
 Address of Applicant :St.Martin's Engineering College, Dhulapally Kompally Secunderabad -----
6)Surkanti Shivani Student, IT
 Address of Applicant :St.Martin's Engineering College, Dhulapally Kompally Secunderabad -----
7)Ravula Srikar Reddy Student, IT
 Address of Applicant :St.Martin's Engineering College, Dhulapally Kompally Secunderabad -----
8)P. Minisha Student, IT
 Address of Applicant :St.Martin's Engineering College, Dhulapally Kompally Secunderabad -----
9)Kara Roopika Student, IT
 Address of Applicant :St.Martin's Engineering College, Dhulapally Kompally Secunderabad -----
10)Sammeta Snehitha Student, IT
 Address of Applicant :St.Martin's Engineering College, Dhulapally Kompally Secunderabad -----
11)Surampudi Deepthi Student, IT
 Address of Applicant :St.Martin's Engineering College, Dhulapally Kompally Secunderabad -----

(57) Abstract :
 We utilize machine learning to analyze the features related to the happiness index and to make some predictions. Using the obtained dataset of the survey that collects a random number of Chinese people's happiness index and asks relevant questions, we provide several algorithms to analyze the relationship between people's happiness index and the answers to the problems they have answered. We can make predictions in the new dataset approximately consistent with the actual values by utilizing the results. In our study, we gain some important features like income, education, and health. This Invention provides some novel perspectives to improve service for e-governance.

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